

FP3415-VB Datasheet

N-Channel 150 V (D-S) MOSFET

PRODUCT SUMMARY

| V_{DS} (V) | $R_{DS(on)}$ (Ω) MAX. | I_D (A) | Q_g (TYP.) |
|--------------|--------------------------------|-----------|--------------|
| 150 | 0.012 at $V_{GS} = 10$ V | 150 | 113 nC |
| | 0.014 at $V_{GS} = 7.5$ V | 135 | |

FEATURES

- Thunder power MOSFET
- Maximum 175 °C junction temperature
- 100 % R_g and UIS tested

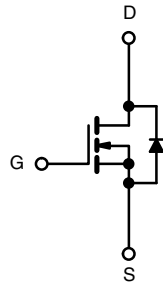


RoHS
COMPLIANT
HALOGEN
FREE

TO-247



Top View



N-Channel MOSFET

APPLICATIONS

- Power supplies:
 - Uninterruptible power supplies
 - AC/DC switch-mode power supplies
 - Lighting
- Synchronous rectification
- DC/DC converter
- Motor drive switch
- DC/AC inverter
- Solar micro inverter
- Class D audio amplifier

ABSOLUTE MAXIMUM RATINGS ($T_C = 25$ °C, unless otherwise noted)

| PARAMETER | SYMBOL | LIMIT | UNIT |
|--|----------------|------------------------|------|
| Drain-Source Voltage | V_{DS} | 150 | V |
| Gate-Source Voltage | V_{GS} | ± 20 | |
| Continuous Drain Current ($T_J = 150$ °C) | $T_C = 25$ °C | I_D 150 | A |
| | $T_C = 125$ °C | 60 | |
| Pulsed Drain Current ($t = 100$ μ s) | I_{DM} | 300 | |
| Avalanche Current | I_{AS} | 60 | |
| Single Avalanche Energy ^a | E_{AS} | 180 | mJ |
| Maximum Power Dissipation ^a | $T_C = 25$ °C | P_D 375 ^b | W |
| | $T_C = 125$ °C | 125 ^b | |
| Operating Junction and Storage Temperature Range | T_J, T_{stg} | -55 to +175 | °C |

THERMAL RESISTANCE RATINGS

| PARAMETER | SYMBOL | LIMIT | UNIT |
|--|------------|-------|------|
| Junction-to-Ambient (PCB Mount) ^c | R_{thJA} | 40 | °C/W |
| Junction-to-Case (Drain) | R_{thJC} | 0.4 | |

Notes

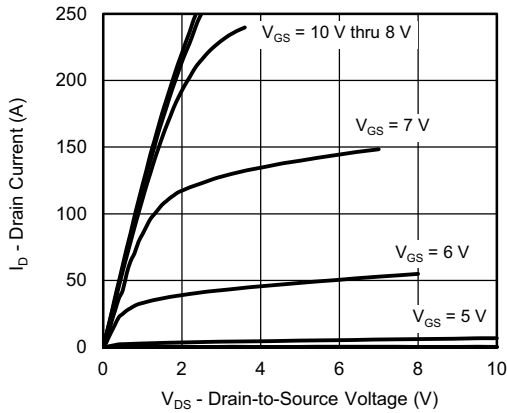
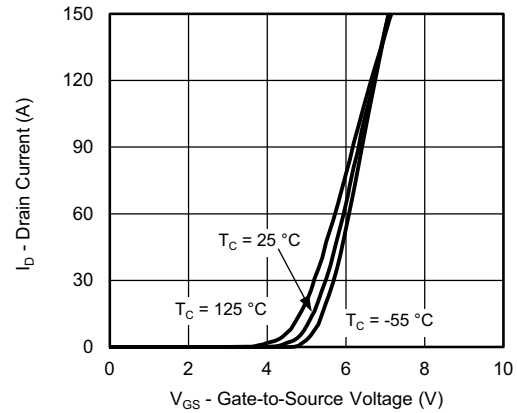
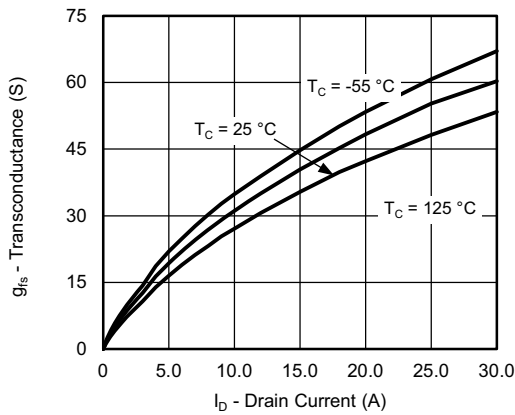
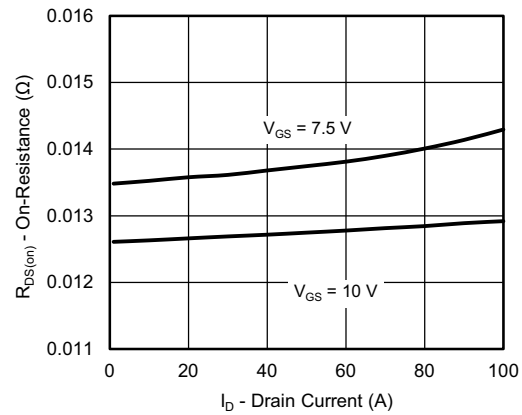
- Duty cycle ≤ 1 %.
- See SOA curve for voltage derating.
- When mounted on 1" square PCB (FR4 material).

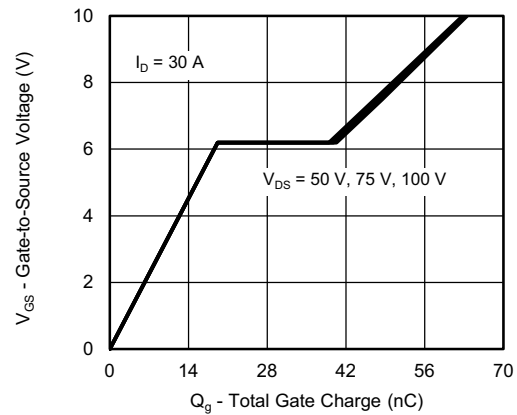
| SPECIFICATIONS (T _J = 25 °C, unless otherwise noted) | | | | | | |
|---|----------------------|---|------|-------|-------|------|
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT |
| Static | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | V _{GS} = 0 V, I _D = 250 μA | 150 | - | - | V |
| Gate Threshold Voltage | V _{GS(th)} | V _{DS} = V _{GS} , I _D = 250 μA | 2 | - | 5 | |
| Gate-Body Leakage | I _{GSS} | V _{DS} = 0 V, V _{GS} = ± 20 V | - | - | ± 250 | nA |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 150 V, V _{GS} = 0 V | - | - | 1 | μA |
| | | V _{DS} = 150 V, V _{GS} = 0 V, T _J = 125 °C | - | - | 100 | |
| | | V _{DS} = 150 V, V _{GS} = 0 V, T _J = 175 °C | - | - | 2 | mA |
| On-State Drain Current ^a | I _{D(on)} | V _{DS} ≥ 10 V, V _{GS} = 10 V | 50 | - | - | A |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = 10 V, I _D = 20 A | - | 0.012 | - | Ω |
| | | V _{GS} = 7.5 V, I _D = 20 A | - | 0.014 | - | |
| Forward Transconductance ^a | g _{fs} | V _{DS} = 15 V, I _D = 20 A | - | 52 | - | S |
| Dynamic ^b | | | | | | |
| Input Capacitance | C _{iss} | V _{GS} = 0 V, V _{DS} = 75 V, f = 1 MHz | - | 6200 | - | pF |
| Output Capacitance | C _{oss} | | - | 535 | - | |
| Reverse Transfer Capacitance | C _{rss} | | - | 26 | - | |
| Total Gate Charge ^c | Q _g | V _{DS} = 75 V, V _{GS} = 10 V, I _D = 30 A | - | 113 | - | nC |
| Gate-Source Charge ^c | Q _{gs} | | - | 19.5 | - | |
| Gate-Drain Charge ^c | Q _{gd} | | - | 20.5 | - | |
| Gate Resistance | R _g | f = 1 MHz | 1.5 | 3 | 5 | Ω |
| Turn-On Delay Time ^c | t _{d(on)} | V _{DD} = 75 V, R _L = 1.25 Ω I _D ≅ 60 A, V _{GEN} = 10 V, R _g = 1 Ω | - | 15 | 30 | ns |
| Rise Time ^c | t _r | | - | 114 | 220 | |
| Turn-Off Delay Time ^c | t _{d(off)} | | - | 28 | 56 | |
| Fall Time ^c | t _f | | - | 8 | 16 | |
| Drain-Source Body Diode Ratings and Characteristics ^b (T _C = 25 °C) | | | | | | |
| Pulsed Current (t = 100 μs) | I _{SM} | | - | - | 200 | A |
| Forward Voltage ^a | V _{SD} | I _F = 30 A, V _{GS} = 0 V | - | 0.73 | 1.2 | V |
| Reverse Recovery Time | t _{rr} | I _F = 30 A, di/dt = 100 A/μs | - | 60 | 120 | ns |
| Peak Reverse Recovery Charge | I _{RM(REC)} | | - | 10 | 20 | A |
| Reverse Recovery Charge | Q _{rr} | | - | 0.5 | 1 | μC |

Notes

- a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.
b. Guaranteed by design, not subject to production testing.
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)

Output Characteristics

Transfer Characteristics

Transconductance

On-Resistance vs. Drain Current

Capacitance

Gate Charge

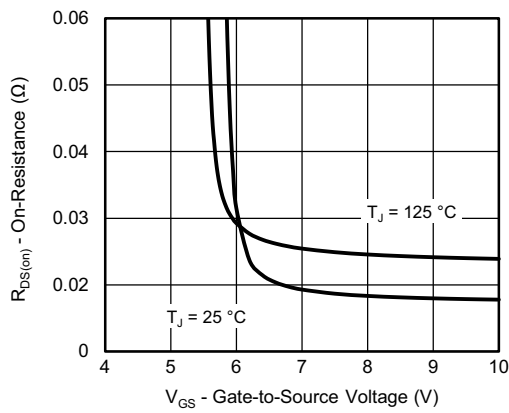
TYPICAL CHARACTERISTICS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)



On-Resistance vs. Junction Temperature



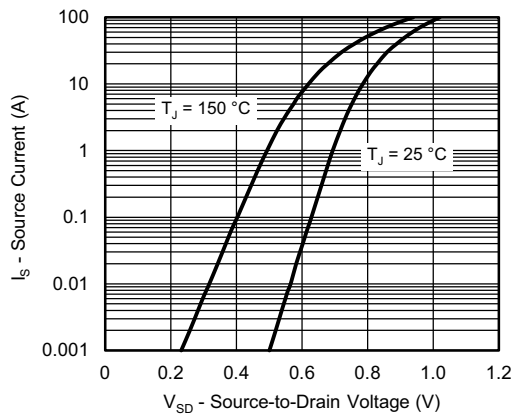
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage



Drain Source Breakdown vs. Junction Temperature

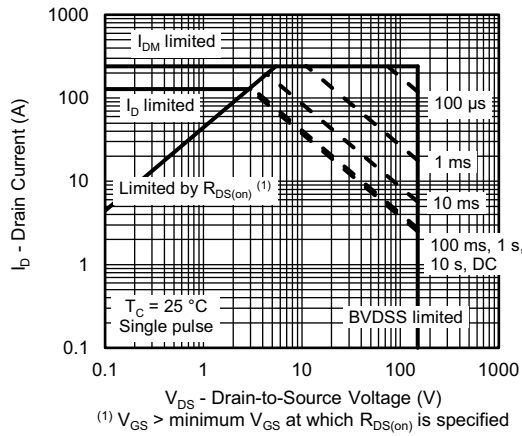


Source Drain Diode Forward Voltage



Current De-Rating

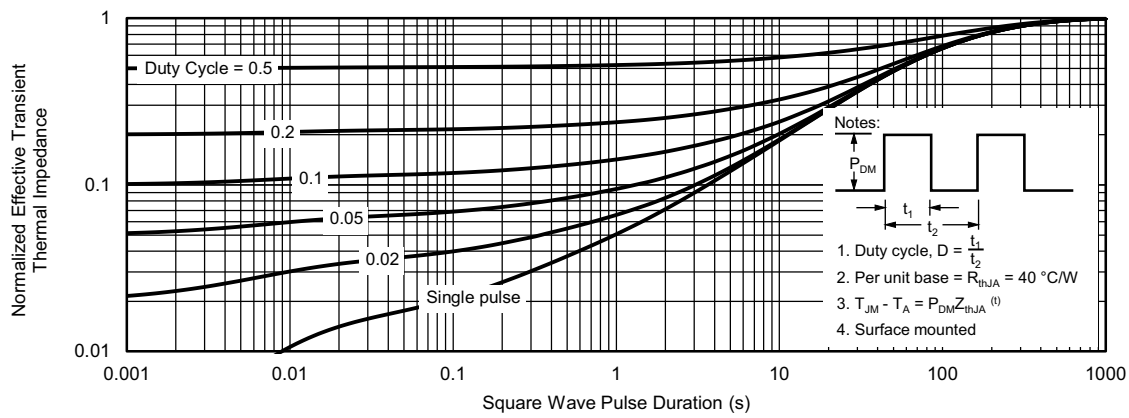
THERMAL RATINGS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)



Safe Operating Area

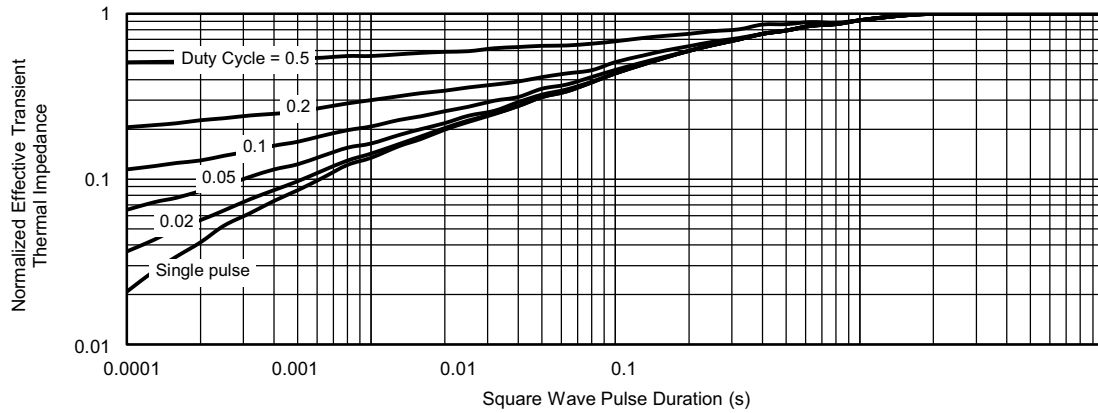


I_{DAV} vs. Time



Normalized Thermal Transient Impedance, Junction-to-Ambient

THERMAL RATINGS ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction to Ambient ($25\text{ }^{\circ}\text{C}$)
 - Normalized Transient Thermal Impedance Junction to Case ($25\text{ }^{\circ}\text{C}$)
- are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

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| DIM. | MILLIMETERS | | INCHES | |
|------|-------------|-------|-----------|-------|
| | MIN. | MAX. | MIN. | MAX. |
| A | 4.70 | 5.31 | 0.185 | 0.209 |
| A1 | 2.21 | 2.59 | 0.087 | 0.102 |
| A2 | 1.50 | 2.49 | 0.059 | 0.098 |
| b | 0.99 | 1.40 | 0.039 | 0.055 |
| b2 | 1.65 | 2.41 | 0.065 | 0.095 |
| b4 | 2.59 | 3.43 | 0.102 | 0.135 |
| c | 0.61 BSC | | 0.024 BSC | |
| D | 20.80 | 21.46 | 0.819 | 0.845 |
| D1 | 3.68 | 5.49 | 0.145 | 0.216 |
| (e) | 5.46 BSC | | 0.215 BSC | |
| E | 15.49 | 16.26 | 0.610 | 0.640 |
| L | 19.81 | 20.32 | 0.780 | 0.800 |
| L1 | 4.06 | 4.50 | 0.160 | 0.177 |
| Ø p | 3.51 | 3.66 | 0.138 | 0.144 |
| | | | | |

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